

- Low-loss SAW Filter
- Surface-mount 3.0 x 3.0 x 1.4 mm Package
- Complies with Directive 2002/95/EC (RoHS)

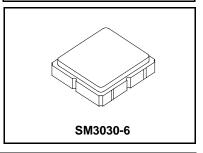


Absolute Maximum Ratings

Rating	Value	Units
Input Power Level	10	dBm
DC Voltage on any Non-ground Terminal	3	V
Operating Temperature Range	-20 to +50	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Solder Reflow Temperature, 10 seconds, 5 cycles maximum	260	°C

1472 MHz **SAW Filter**

SF2177E-1



Electrical Characteristics

Characteristic	Sym	Notes	Min	Тур	Max	Units	
Center Frequency	F _C			1472		MHz	
Insertion Loss, 1452 to 1492 MHz	IL			3.3	4.5	dB	
Amplitude Ripple, 1452 to 1492 MHz				1.0	2.0	dB _{P-P}	
Attenuation Referenced to 0 dB							
1230 to 1330 MHz			40	55			
1570 to 1670 MHz			30	47		dB	
1670 to 1715 MHz			36	48			
Source Impedance	Z _S			50		Ω	
Load Impedance	Z _L			50		52	
Case Style	SM3030-6 3.0 x 3.0 mm Nominal Footprint						
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	983, YWWS						
Standard Reel Quantity Reel Size 7 Inch	500 Pieces/Reel						
Reel Size 13 Inch	3000 Pieces/Reel						

Electrical Connections

Connection	Terminals
Input	2
Output	5
Ground	All Others

CAUTION: Electrostatic Sensitive Device. Observe precautions for handling. Notes:

- Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
- Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
- Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external

- impedance matching design. See Application Note No. 42 for details.

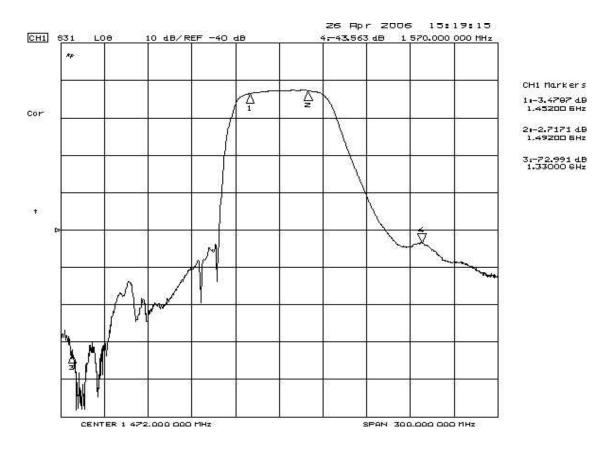
 "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."

 The design, manufacturing process, and specifications of this filter are subject to change.

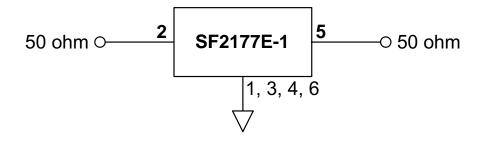
 Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
- US and international patents may apply.

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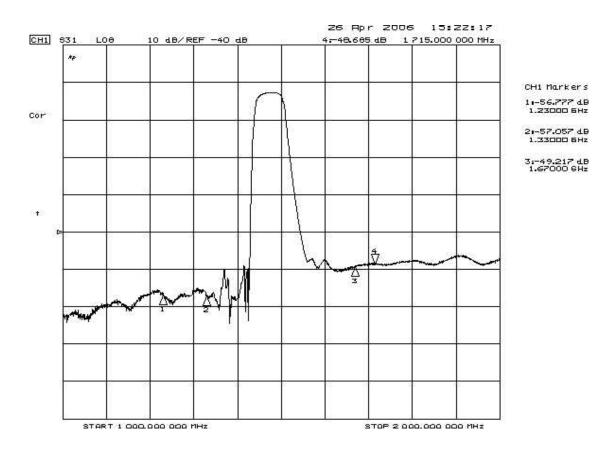
Filter Passband Response



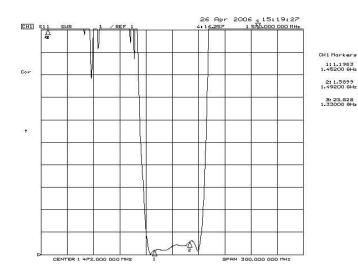
Filter Test Circuit

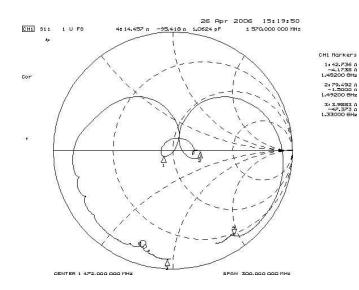


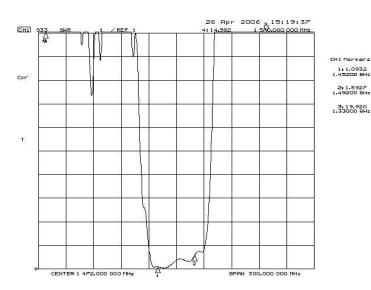
Filter Broadband Response

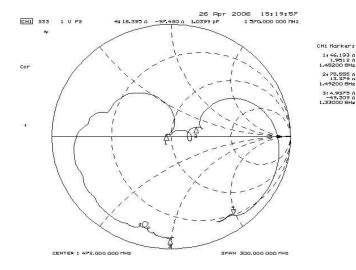


Input and Output VSWR Plots





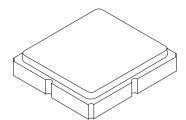


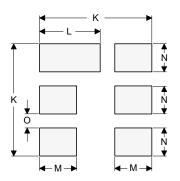


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SM3030-6 Case

6-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint





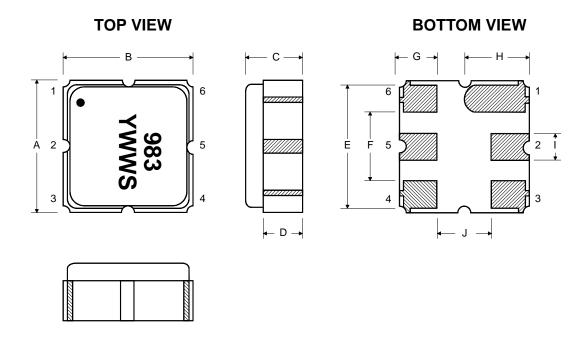
PCB Footprint Top View

Case and PCB Footprint Dimensions

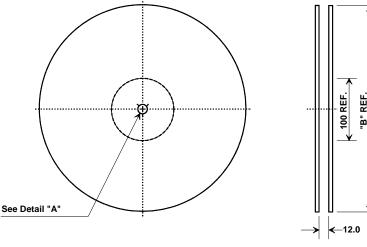
Dimension	mm			Inches			
Dilliension	Min	Nom	Max	Min	Nom	Max	
Α	2.87	3.00	3.13	0.113	0.118	0.123	
В	2.87	3.00	3.13	0.113	0.118	0.123	
С	1.12	1.25	1.38	0.044	0.049	0.054	
D	0.77	0.90	1.03	0.030	0.035	0.040	
E	2.67	2.80	2.93	0.105	0.110	0.115	
F	1.47	1.60	1.73	0.058	0.063	0.068	
G	0.72	0.85	0.98	0.028	0.033	0.038	
Н	1.37	1.50	1.63	0.054	0.059	0.064	
I	0.47	0.60	0.73	0.019	0.024	0.029	
J	1.17	1.30	1.43	0.046	0.051	0.056	
K		3.20			0.126		
L		1.70			0.067		
М		1.05			0.041		
N		0.81			0.032	_	
0		0.38			0.015		

Case Materials

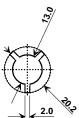
Materials				
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel			
Lid Plating	2.0 to 3.0 µm Nickel			
Body	Al ₂ O ₃ Ceramic			
Pb Free				



Tape and Reel Specifications

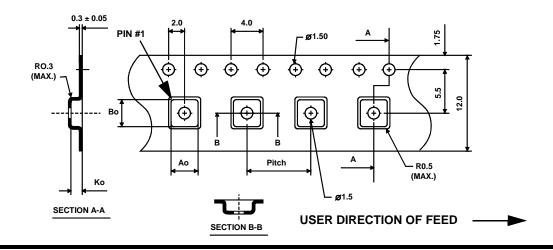


"B"		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	3000



COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions	
Ao	3.3 mm
Во	3.3 mm
Ko	1.6 mm
Pitch	8 mm
W	12 mm



Typical Solder Reflow Profile

